Standalone Linear Li-Ion Charger (1A, two-cell) with Thermal Regulation

General Description

The EMC5046 is a complete linear charger for two-cell lithium-ion batteries. With E-SOP-8 packages and few external components, EMC5046 is well suited for portable applications.

No external sense resistor and blocking diode are required. Charging current can be programmed externally with a single resistor. The built-in thermal regulation facilitates charging with maximum power without risk of overheating.

The EMC5046 always preconditions the battery with 1/10 of the programmed charge current at the beginning of a charge cycle, after it verifies that the battery can be fast-charged. The EMC5046 automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached.

The EMC5046 features 13.5V maximum rating voltage for AC adapter, and it provides the charge current up to 1.0A. Other features include battery temperature monitoring, reverse current protection, shutdown mode, charging current monitor, under voltage lockout, automatic recharge and status indicator.

Features

- Programmable charge current up to 1.0A
- No MOSFET, sense resistor or blocking diode required
- Complete linear charger in E-SOP-8 for two-cell li-ion batteries
- Thermal regulation maximizes charge rate without risk of overheating
- Preset 8.4V charge voltage with ±1% accuracy
- Automatic recharge
- Charge status indicator
- C/10 charge termination
- 5.8V trickle charge threshold
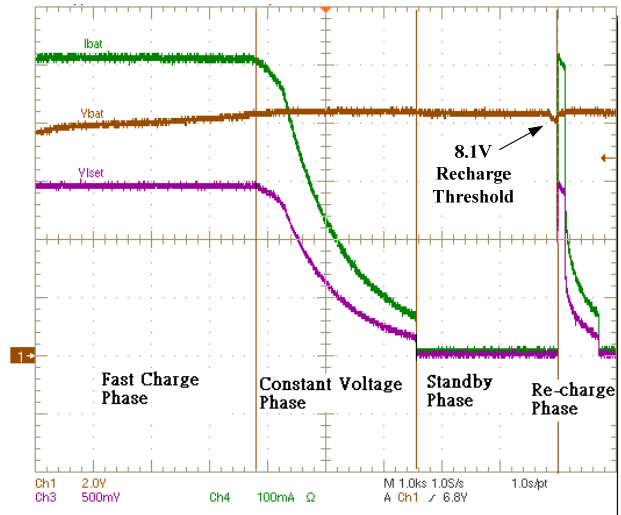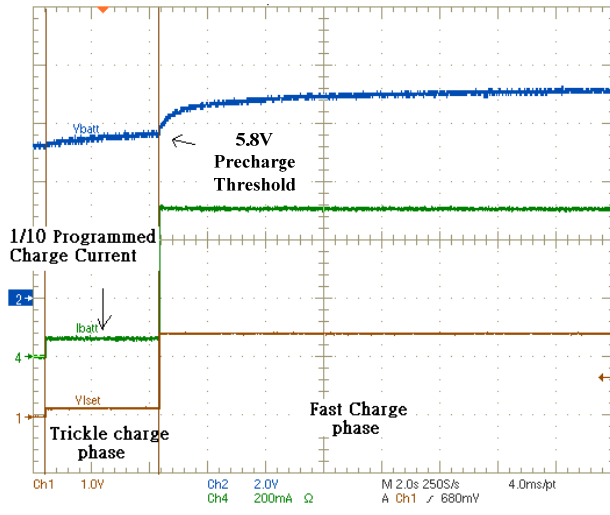- Battery reverse leakage current less than 1uA

Applications

- Wireless handsets
- Hand-held instruments
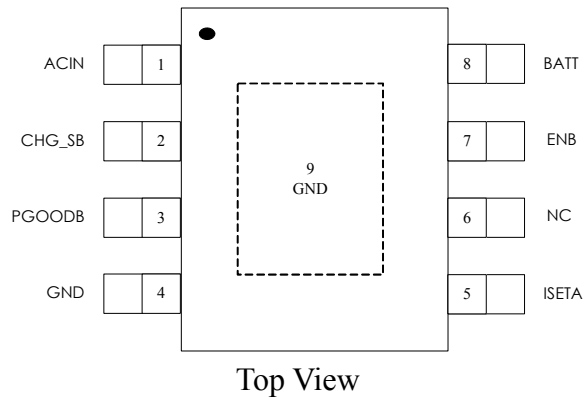- Portable information appliances

Typical Application Circuit
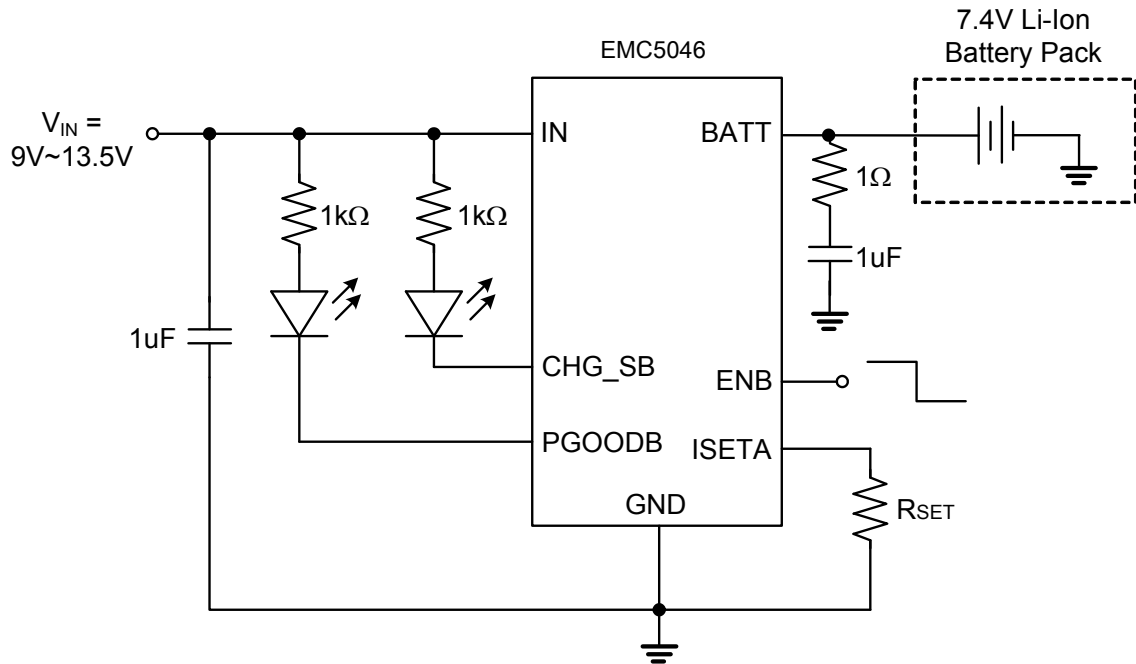
Complete Charger Cycle

Connection Diagrams

ACIN — 1
CHG_SB — 2
PGOODB — 3
GND — 4

9
GND

8 — BATT
7 — ENB
6 — NC
5 — ISETA

Top View

Order information

EMC5046-84SG08NRR
84   Output voltage
SG08   E-SOP-8 Package
NRR   RoHS & Halogen free package
            Rating: -40 to 85°C
            Package in Tape & Reel

Order, Marking & Packing Information

Package	Product ID.	Marking	Packing
E-SOP-8	EMC5046-84SG08NRR	8 7 6 5 **EMP** EMC5046 Tracking code PIN1 DOT 1 2 3 4	Tape & Reel 3Kpcs

Pin Functions

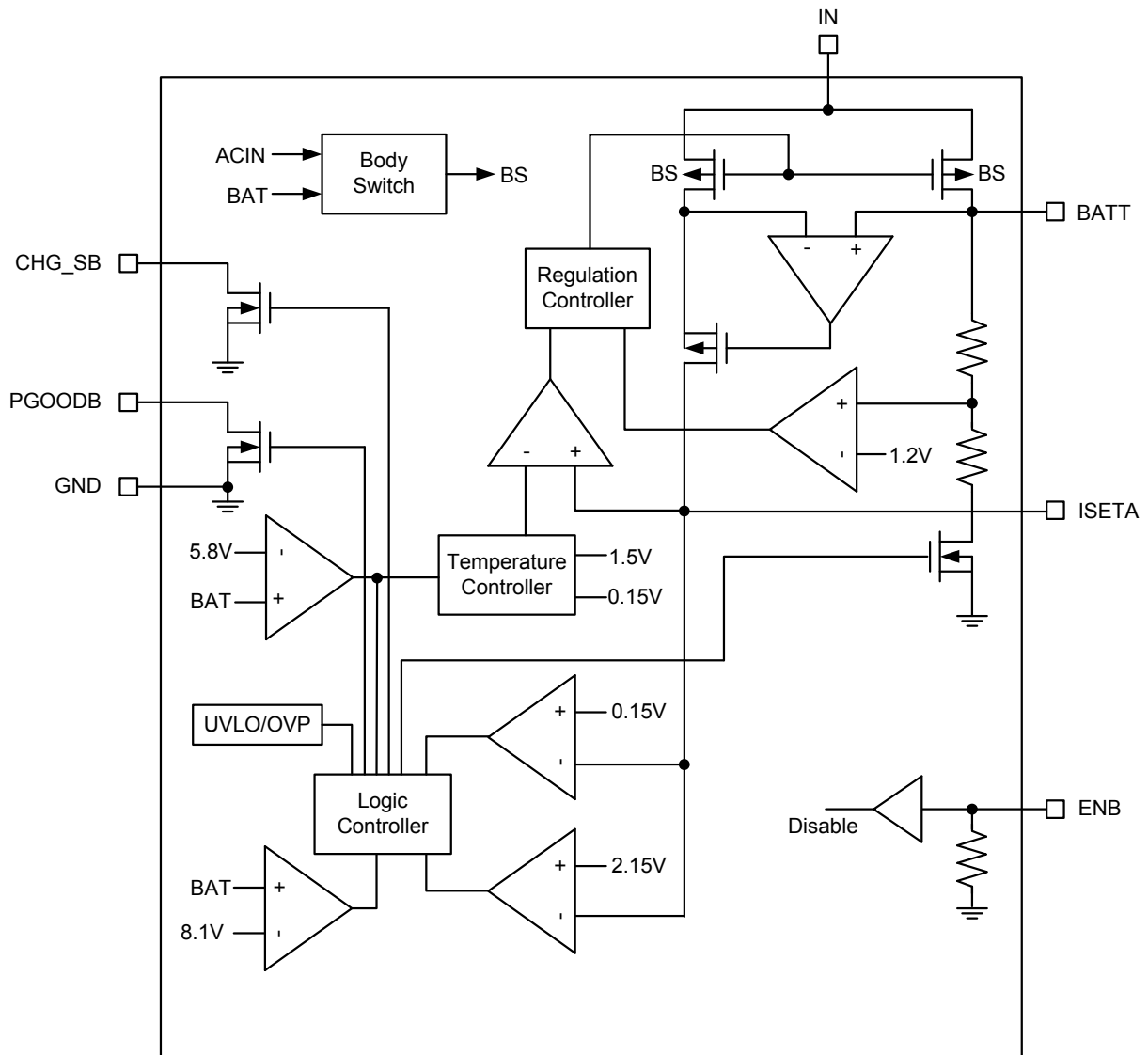| Name	Pin	Function
IN	1	**Positive input supply voltage.** Provides power to the charger, V_{IN} can range from 9V to 13.5V and should be bypassed with at least a 1μF capacitor. When IN pin drops to within 30mV above the BATT pin voltage, the EMC5046 enters shutdown mode, dropping I_{BATT} to less than 1μA.
CHG_SB	2	**Open-Drain charge status output.** An internal N-channel MOSFET connects CHG_SB pin to ground when the battery is charging. After the charge cycle is completed, the internal N-channel MOSFET is replaced by a weak pull-down of approximately 25μA, indicating an "V_{IN} present" condition. When the EMC5046 detects an under voltage lockout condition, CHG_SB is forced high impedance.
PGOODB	3	**Open-Drain battery power good output.** An internal N-channel MOSFET connects PGOODB pin to ground when V_{IN} is reached to 8.4V. PGOODB is forced low during normal operation.
GND	4	**Ground.**
ISETA	5	**Charge current program, charge current monitor and shutdown pin.** The charge current is programmed by connecting a 1% resistor, R_{SET}, to ground. When charging in constant-current mode, this pin servos to 1.5V. In all modes, the voltage on this pin can be used to measure the charge current using the following formula: $$I_{BATT} = (V_{SET} / R_{SET}) * 500$$ The ISETA pin can also be used to shutdown the charger. Disconnecting the program resistor from ground allows a 1μA current to pull the ISETA pin high. When it reaches the 2.15V shutdown threshold voltage, the charger enters shutdown mode. This pin is also clamped to approximately 2.5V. Reconnecting R_{SET} to ground will return the charger to normal operation. **The ISETA pin must not be directly shorted to ground at any condition.**
NC	6	**Not connected.**
ENB	7	**Charge enable input (active low).** This pin is weakly pulled low internally.
BATT	8	**Charge current output and battery voltage feedback.** This pin provides charge current to the battery and regulates the final float voltage to 8.4V. An internal precision resistor divider from this pin sets the float voltage which is disconnected in shutdown mode.
GND	9	**Thermal ground area.**

Functional Block Diagram

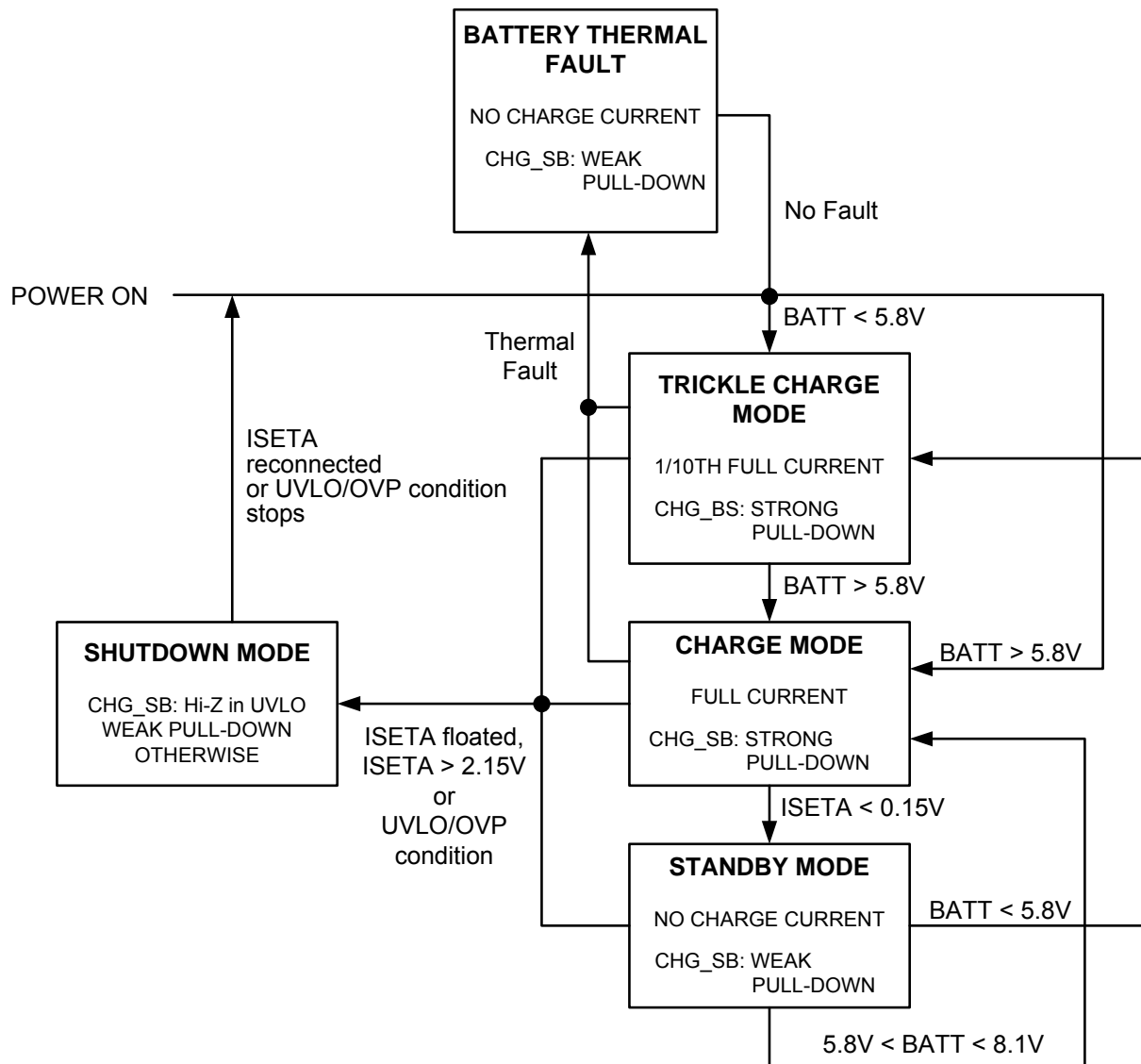FIG.1 Functional Block Diagram of EMC5046

State Diagram

BATTERY THERMAL FAULT

NO CHARGE CURRENT

CHG_SB: WEAK PULL-DOWN

No Fault

POWER ON

Thermal Fault

BATT < 5.8V

TRICKLE CHARGE MODE

1/10TH FULL CURRENT

CHG_BS: STRONG PULL-DOWN

ISETA reconnected or UVLO/OVP condition stops

BATT > 5.8V

SHUTDOWN MODE

CHG_SB: Hi-Z in UVLO WEAK PULL-DOWN OTHERWISE

ISETA floated, ISETA > 2.15V or UVLO/OVP condition

CHARGE MODE

FULL CURRENT

CHG_SB: STRONG PULL-DOWN

BATT > 5.8V

ISETA < 0.15V

STANDBY MODE

NO CHARGE CURRENT

CHG_SB: WEAK PULL-DOWN

BATT < 5.8V

5.8V < BATT < 8.1V

FIG.2 EMC5046 charge flow chart

Absolute Maximum Ratings (Notes 1, 2)

V_{IN}, V_{BATT}, V_{CHGSB}, V_{PROODB}, V_{EN}	-0.3V to 15V	Storage Temperature Range	-65°C to 150°C
V_{ISETA}	-0.3V to 3.6V	Junction Temperature (T_J)	150°C
Power Dissipation	(Note 5)	Lead Temperature (Soldering, 10 sec.)	260°C

Operating Ratings (Note 1, 2)

Supply Voltage	9V to 13.5V	Thermal Resistance (θ_{JC} , Note 4))	
Operating Temperature Range	-40°C to 85°C	E-SOP-8L	15°C/W
Thermal Resistance (θ_{JA} , Note 3))			
E-SOP-8L	75°C/W		

Electrical Characteristics

T_A = 25°C, V_{IN} = 10V; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{IN}	Input Operating Voltage Range		9	10	13.5	V
I_{CC}	Input Supply Current	Charge Mode, R_{SET} = 30K (Note 6)		300		uA
		Standby Mode (Charge Terminated)		250		uA
		Shutdown Mode (R_{SET} Not Connected, V_{IN} < V_{BATT} or V_{IN} < V_{UV})		190		uA
V_{FLOAT}	Regulated Output (Float) Voltage		8.356	8.44	8.524	V
I_{BATT}	BATT Pin Current	R_{SET} = 1.5K, Current Mode		500		mA
		R_{SET} = 0.75K, Current Mode		1000		mA
		Standby Mode, V_{BATT} = 8.4V	-1	0	1	uA
		Shutdown Mode	-1	0	1	uA
		Sleep Mode, V_{IN} = 0V	-1	0	1	uA
$I_{TRICKLE}$	Trickle Charge Current	V_{BATT} < $V_{TRICKLE}$, R_{SET} = 1.5K		60		mA
		V_{BATT} < $V_{TRICKLE}$, R_{SET} = 0.75K		120		mA
$V_{TRICKLE}$	Trickle Charge Threshold Voltage	R_{SET} = 1.5K, V_{BATT} Rising		5.8		V
V_{TRHYS}	Trickle Charge Hysteresis Voltage	R_{SET} = 1.5K		250		mV
V_{MSD}	Manual Shutdown Threshold Voltage	ISETA Pin Rising		2.15		V
		ISETA Pin Falling		2.05		V
V_{ASD}	V_{IN}-V_{BATT} Lockout Threshold Voltage	V_{IN} from High to Low		30		mV
		V_{IN} from Low to High		60		mV
I_{TERM}	C/10 Termination Current Threshold	R_{SET} = 1.5K		0.1		mA/mA
		R_{SET} = 0.75K		0.1		mA/mA
V_{SET}	ISETA Pin Voltage	R_{SET} = 1.5K, Current Mode		1.5		V
I_{CHG_SB}	CHG_SB Pin Weak Pull-Down Current	V_{CHG_SB} = 5.0V		25		uA

V_{CHG_SB}	CHG_SB Pin Output Low Voltage	I_{CHG_SB} = 5mA		0.35		V
V_{POOGDB}	PGOODB Pin Output Low Voltage	I_{PGOODB} = 5mA		0.35		V
$\triangle V_{RECHRG}$	Recharge Battery Threshold Voltage	V_{FLOAT} - $V_{BATT-RECHRG}$		300		mV
T_{ILM}	Junction Temperature in Constant Temperature Mode (Thermal Regulation)			120		℃
R_{ON}	Power FET "ON" Resistance	I_{BATT} = 500mA		375		mΩ
$T_{RECHARGE}$	Recharge Comparator Filter Time	V_{BATT} High to Low		150		us
T_{TERM}	Termination Comparator Filter Time	I_{BATT} Falling Below I_{CHG}/10		1		ms
I_{SET}	ISETA Pin Pull-up Current			1		uA
V_{RUN}	Enable Threshold				0.55	V
	Shutdown Threshold		2.8			V

Note 1: Absolute Maximum ratings indicate limits beyond which damage may occur. Electrical specifications do not apply when operating the device outside of its rated operating conditions.

Note 2: All voltages are with respect to the potential at the ground pin.

Note 3: θ_{JA} is measured in the natural convection at T_A=25℃ on a high effective thermal conductivity test board (2 layers, 2S0P).

Note 4: θ_{JC} represents the resistance to the heat flows the chip to package top case.

Note 5: Maximum Power dissipation for the device is calculated using the following equations:
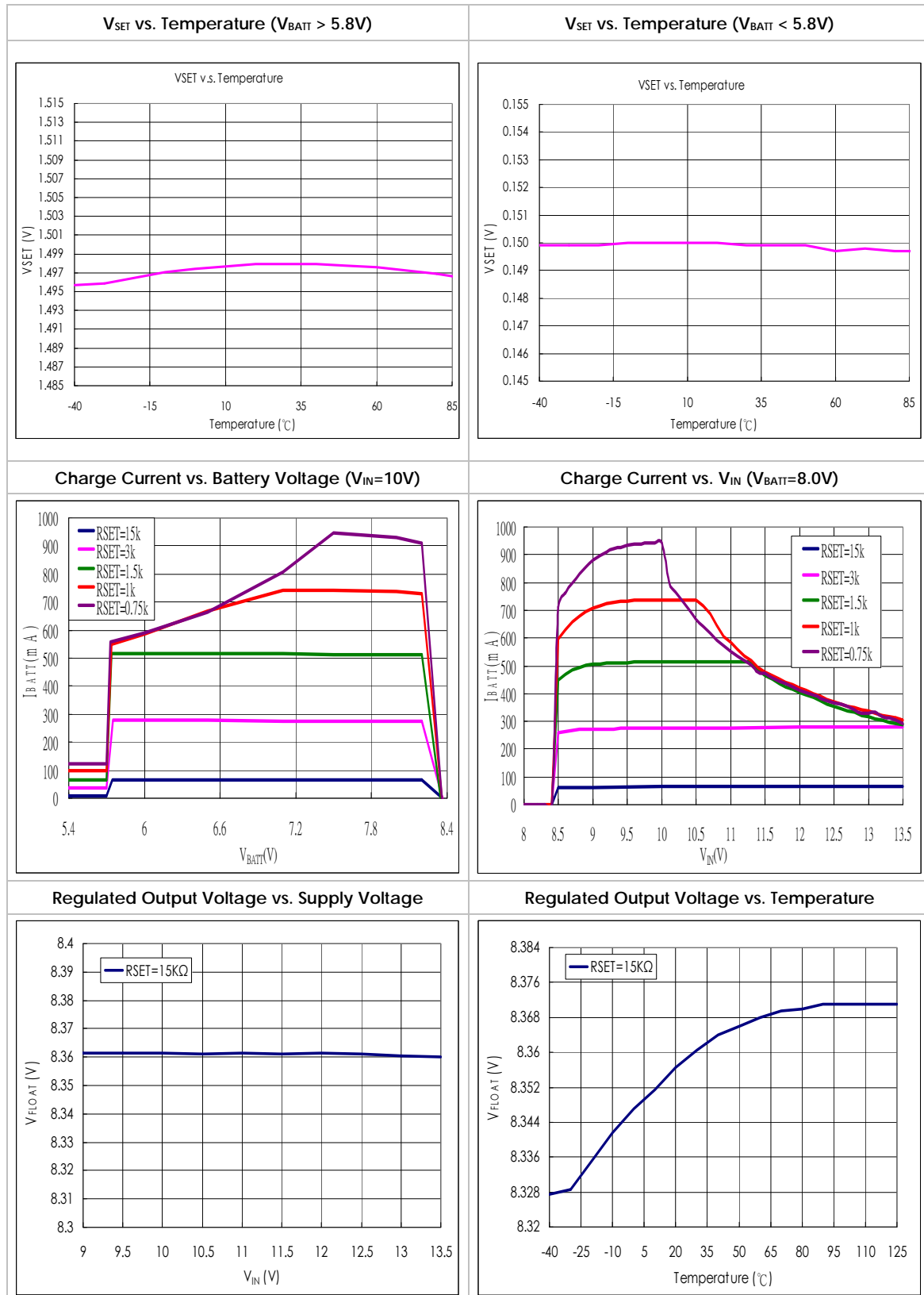
$$P_D = \frac{T_{ILM\,(Thermal\,Regulation)} - T_A}{\theta_{JA}}$$

Where T_{ILM} is the thermal regulation temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance. E.g. for the E-SOP-8 package θ_{JA} = 75°C/W, T_{ILM} = 120°C and using T_A = 25°C, the maximum power dissipation is found to be 1.27W. The de-rating factor (-1/θ_{JA}) = -13.33mW/°C, thus below 25°C the power dissipation figure can be increased by 13.33mW per degree, and similarity decreased by this factor for temperatures above 25°C.

Note 6: Supply current includes ISETA pin current but does not include any current delivered to the battery through the BATT pin.
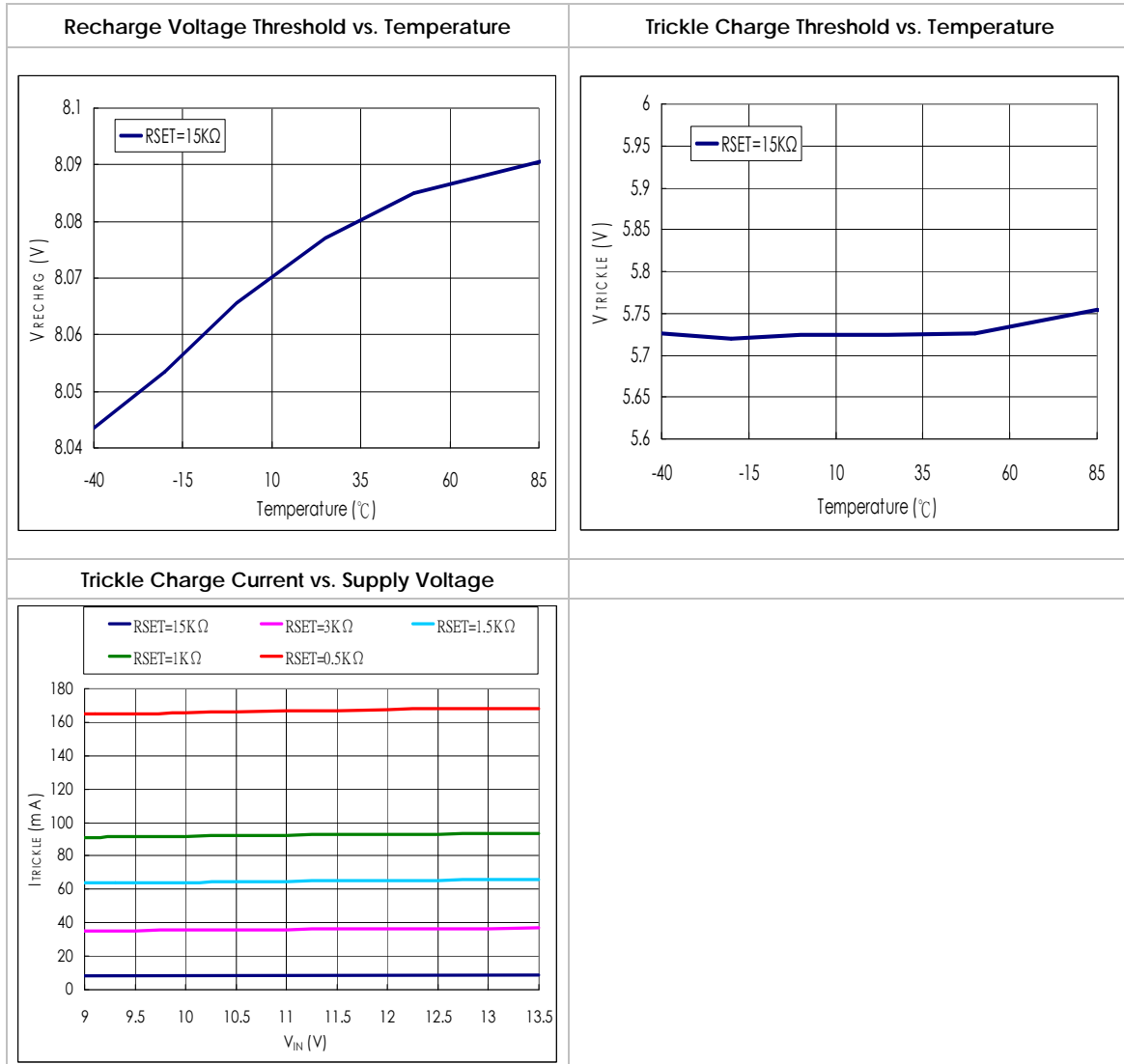
Typical Performance Characteristics

Unless otherwise specified, V_{IN} = 10V, T_A = 25°C

V_{SET} vs. Temperature (V_{BATT} > 5.8V)

V_{SET} vs. Temperature (V_{BATT} < 5.8V)

Charge Current vs. Battery Voltage (V_{IN}=10V)

Charge Current vs. V_{IN} (V_{BATT}=8.0V)

Regulated Output Voltage vs. Supply Voltage

Regulated Output Voltage vs. Temperature

Typical Performance Characteristics (continued)

Unless otherwise specified, V_{IN} = 10V, T_A = 25°C

Recharge Voltage Threshold vs. Temperature

Trickle Charge Threshold vs. Temperature

Trickle Charge Current vs. Supply Voltage

Operation

The EMC5046 is a two-cell lithium-ion battery charger using a constant-current/constant-voltage algorithm. It can deliver up to 1.0A of charge current (using a good thermal PCB layout) with a final float voltage accuracy of ±1%. The EMC5046 includes an internal P-channel power MOSFET and thermal regulation circuitry. No blocking diode or external current sense resistor is required; thus, the basic charger circuit requires only two external components.

Normal Charge Cycle

A charge cycle begins when the voltage at the IN pin rises above the UVLO threshold level and a 1% program resistor is connected from the ISETA pin to ground or when a battery is connected to the charger output. If the BATT pin is less than 5.8V, the charger enters trickle charge mode. In this mode, the EMC5046 supplies approximately 1/10 the programmed charge current to bring the battery voltage up to a safe level for full current charging. When the BATT pin voltage rises above 5.8V, the charger enters constant-current mode, where the programmed charge current is supplied to the battery. When the BATT pin approaches the final float voltage (8.4V), the EMC5046 enters constant-voltage mode and the charge current begins to decrease. When the charge current drops to 1/10 of the programmed value, the charge cycle ends.

Programming Charge Current

The charge current is programmed using a single resistor from the ISETA pin to ground. The battery charge current is 500 times the current out of the ISETA pin. VSET is 1.5V when charging in constant-current mode. The program resistor and the charge current are calculated using the following equations:

$$R_{SET} = \frac{500V_{SET}}{I_{CHG}}, \quad I_{CHG} = \frac{500V_{SET}}{R_{SET}}$$

The charge current out of the BATT pin can be determined at any time by monitoring the ISETA pin voltage using the following equation:

$$I_{BATT} = \frac{V_{SET}}{R_{SET}} \times 500$$

Charge Termination

A charge cycle is terminated when the charge current falls to 1/10th the programmed value after the final float voltage is reached. This condition is detected by using an internal, filtered comparator to monitor the ISETA pin. When the ISETA pin voltage falls below 150mV for longer than T_{TERM} (typically 1ms), charging is terminated. The charge current is latched off and the EMC5046 enters standby mode, where the input supply current drops to 150uA. (Note: C/10 termination is disabled in trickle charging and thermal limiting modes). The EMC5046 draws no current from the battery in standby mode. This feature reduces the charge and discharge cycles on the battery, further prolonging the battery life.

Any external source (V_{SET}) that holds the ISETA pin above 150mV will prevent the EMC5046 from terminating a charge cycle. However, if the ISETA pin is controlled by external source, current sourcing from the BATT pin can be infinity (until the internal power MOSFET is burned out or the BATT pin voltage is close to its final float voltage), and the formula for charge current is not valid anymore.

When charging, transient loads on the BATT pin can cause the ISETA pin to fall below 150mV for short periods of time before the DC charge current has dropped to 1/10th the programmed value. The 1ms filter time (T_{TERM}) on the termination comparator ensures that transient loads of this nature do not result in premature charge cycle termination. Once the average charge current drops below 1/10th the programmed value, the EMC5046 terminates the charge cycle and ceases to provide any current through the BATT pin. This is the standby mode, and all loads on the BATT pin must be supplied by the battery. In the standby mode, any signal below the manual shutdown threshold voltage (typically 2.15V) on the ISETA pin is transparent to EMC5046.

The EMC5046 constantly monitors the BATT pin voltage in standby mode. If this voltage drops below the 8.1V recharge threshold (V_{RECHRG}), another charge cycle begins and current is once again supplied to the battery. To manually restart a charge cycle when in standby mode, the input voltage must be removed and reapplied, or the charger must be shut down and restarted using the ISETA pin.

Charge Status Indicator (CHG_SB)

The charge status output has three different states: strong pull-down (~10mA), weak pull-down (~25uA) and high impedance. The strong pull-down state indicates that the EMC5046 is in a charge cycle. Once the charge cycle has terminated, the pin state is determined by under-voltage lockout conditions. A weak pull-down indicates that V_{IN} meets the UVLO conditions and the EMC5046 is ready to charge. High impedance indicates that the EMC5046 is in under-voltage lockout mode: either V_{IN} is less than 60mV of the BATT pin voltage or insufficient voltage is applied to the IN pin. A microprocessor can be used to distinguish between these three states. This method is discussed in the Applications Information section.

Thermal Limiting

An internal thermal feedback loop reduces the programmed charge current if the die temperature attempts to rise above a preset value of approximately 125°C. This feature protects the EMC5046 from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the EMC5046. The charge current can be set according to typical (not worst-case) ambient temperature with the assurance that the charger will automatically reduce the current in worst-case conditions. E-SOP-8 power considerations are discussed further in the Applications Information section.

Under-voltage Lockout (UVLO)

An internal under-voltage lockout circuit monitors the input voltage and keeps the charger in shutdown mode until V_{IN} rises above the under-voltage lockout threshold. The UVLO circuit has a built-in hysteresis of 150mV. Furthermore, to protect against reverse current in the power MOSFET, the UVLO circuit keeps the charger in shutdown mode if V_{IN} falls to within 30mV of the battery voltage. If the UVLO comparator is tripped, the charger will not come out of shutdown mode until V_{IN} rises 60mV above the battery voltage.

Manual Shutdown

At any point in the charge cycle, the EMC5046 can be put into shutdown mode by removing R_{SET} thus floating the ISETA pin. This reduces the battery drain current to about to 0uA and the supply current to less than 150uA. A new charge cycle can be initiated by reconnecting the program resistor.

In manual shutdown, the CHG_SB pin is in a weak pull- down state as long as V_{IN} is high enough to exceed the UVLO conditions. The CHG_SB pin is in a high impedance state if the EMC5046 is in under-voltage lockout mode: either V_{IN} is within 60mV of the BATT pin voltage or insufficient voltage is applied to the IN pin.

Automatic Recharge

Once the charge cycle is terminated, the EMC5046 continuously monitors the voltage on the BATT pin using a comparator with a 150us filter time ($T_{RECHARGE}$). A charge cycle restarts when the battery voltage falls below 8.1V (which corresponds to approximately 80% to 90% battery capacity). This ensures that the battery is kept at or near a fully charged condition and eliminates the need for periodic charge cycle initiations. CHG_SB output enters a strong pull-down state during recharge cycles.

Application Information

Stability Considerations

The constant-voltage mode feedback loop is stable without an output capacitor provided a battery is connected to the charger output. With no battery present, an output capacitor is recommended to reduce ripple voltage. When using high value, low ESR ceramic capacitors, it is recommended to add a 1Ω resistor in series with the capacitor. No series resistor is needed if tantalum capacitors are used.

In constant-current mode, the ISETA pin is in the feedback loop, not the battery. The constant-current mode stability is affected by the impedance at the ISETA pin. With no additional capacitance on the ISETA pin, the charger is stable with program resistor values as high as 100k. However, additional capacitance on this node reduces the maximum allowed program resistor. The pole frequency at the ISETA pin should be kept above 100kHz. Therefore, if the ISETA pin is loaded with a capacitance, C_{SET}, the following equation can be used to calculate the maximum resistance value for R_{SET}:

$$R_{SET} \le \frac{1}{2\pi \times 10^5 \times C_{SET}}$$

Average, rather than instantaneous, charge current may be of interest to the user. For example, if a switching power supply operating in low current mode is connected in parallel with the battery, the average current being pulled out of the BATT pin is typically of more interest than the instantaneous current pulses. In such a case, a simple RC filter can be used on the ISETA pin to measure the average battery current as shown in Figure 3. A 10kΩ resistor has been added between the ISETA pin and the filter capacitor to ensure stability.
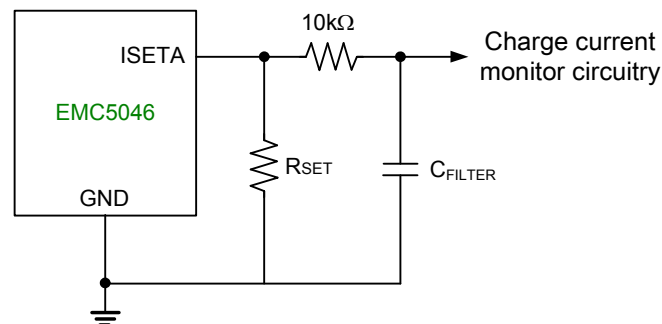
FIG.3 Isolating capacitive load on ISETA pin and filtering

Power Dissipation

The conditions that cause the EMC5046 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Nearly all of this power dissipation is generated by the internal MOSFET, this is calculated to be approximately:

$P_D = (V_{IN} - V_{BATT}) \bullet I_{BATT}$

Where P_D is the power dissipated, V_{IN} is the input supply voltage, V_{BATT} is the battery voltage and I_{BATT} is the charge current. The approximate ambient temperature at which the thermal feedback begins to protect the IC is:

$T_A = 120℃ - P_D \bullet \theta_{JA}$
$T_A = 120℃ - (V_{IN} - V_{BATT}) \bullet I_{BATT} \bullet \theta_{JA}$

Example:
An EMC5046 operating from a 9V supply is programmed to supply 500mA full-scale current to a discharged Li-Ion battery with a voltage of 7.4V. Assuming θ_{JA} is 75℃/W, the ambient temperature at which the EMC5046 will begin to reduce the charge current is approximately:

$T_A = 120℃ - (9V - 7.4V) \bullet (500mA) \bullet 75℃/W$
$T_A = 120℃ - 0.8W \bullet 75℃/W = 120℃ - 60℃$
$T_A = 60℃$

Using the previous example with an ambient temperature of 70℃, the charge current will be reduced to approximately:

$$I_{BATT} = \frac{120^o C - T_A}{(V_{IN} - V_{BATT}) \times \theta_{JA}}$$

$$I_{BATT} = \frac{120^o C - 70^o C}{(9 - 7.4) \bullet 75^o C/W} = \frac{50^o C}{120^o C/A}$$

$$I_{BATT} = 416.7 mA$$

Moreover, when thermal feedback reduces the charge current, the voltage at the ISETA pin is also reduced proportionally as discussed in the Operation section. It is important to remember that EMC5046 applications do not need to be designed for worst-case thermal conditions since the IC will automatically reduce power dissipation when the junction temperature reaches approximately 120℃.

Thermal Considerations

Because of the small size of the E-SOP-8 package, it is very important to use a good thermal PC board layout to maximize the available charge current. The thermal path for the heat generated by the IC is from the die to the copper lead frame, through the package leads, (especially the ground lead) to the PC board copper. The PC board copper is the heat sink. The footprint copper pads (thermal land) should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Feed-through vias to inner or backside copper layers are also useful in improving the overall thermal performance of the charger. Other heat sources on the board, not related to the charger, must also be considered when designing a PC board layout because they will affect overall temperature rise and the maximum charge current.

Increasing Thermal Regulation Current

Reducing the voltage drop across the internal MOSFET can significantly decrease the power dissipation in the IC. This has the effect of increasing the current delivered to the battery during thermal regulation. One method is by dissipating some of the power through an external component, such as a resistor or diode.

Example: An EMC5046 operating from a 9V wall adapter is programmed to supply 1A full-scale current to a discharged Li-Ion battery with a voltage of 7.4V. Assuming θ_{JA} is 75℃/W, the approximate charge current at an ambient temperature of 25℃ is:

$$I_{BATT} = \frac{120^o C - 25^o C}{(9V - 7.4V) \bullet 75^o C/W} = 791.7 mA$$

By dropping voltage across a resistor in series with a 10V wall adapter (shown in Figure 4), the on-chip power dissipation can be decreased, thus increasing the thermally regulated charge current
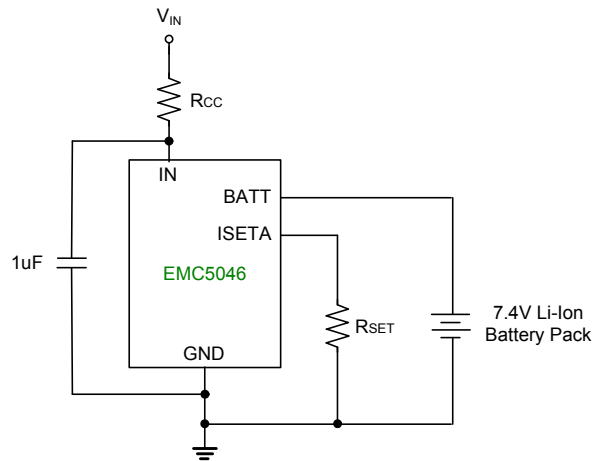
FIG.4 A circuit to maximize charge current

$$I_{BATT} = \frac{120^\circ C - 25^\circ C}{(V_{IN} - I_{BATT}R_{CC} - V_{BATT}) \bullet \theta_{JA}}$$

Solving for I$_{BATT}$ using the quadratic formula.

$$I_{BATT} = \frac{1}{2R_{CC}}[(V_{IN} - V_{BATT}) - \sqrt{(V_{IN} - V_{BATT})^2 - \frac{4R_{CC}(120^\circ C - T_A)}{\theta_{JA}}}]$$

(Note: Large values of R$_{CC}$ will result in no solution for I$_{BATT}$. This indicates that the EMC5046 will not generate enough heat to require thermal regulation.)

Using R$_{CC}$ = 0.5Ω, V$_{IN}$ = 9V, V$_{BATT}$ = 7.4V, T$_A$ = 25℃ and θ $_{JA}$ = 75℃/W we can calculate the thermally regulated charge current to be:

I$_{BATT}$ = 1.437A

While this application delivers more energy to the battery and reduces charge time in thermal mode, it may actually lengthen charge time in voltage mode if V$_{IN}$ becomes low enough to put the EMC5046 into dropout.

This technique works best when R$_{CC}$ values are minimized to keep component size small and avoid dropout. Remember to choose a resistor with adequate power handling capability.

V$_{IN}$ Bypass Capacitor
Many types of capacitors can be used for input bypassing, however, caution must be exercised when using multilayer ceramic capacitors. Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the charger input to a live power source. Adding a 1.5Ω resistor in series with an X5R ceramic capacitor will minimize start-up voltage transients.

Charge Current Soft-Start
The EMC5046 includes a soft-start circuit to minimize the inrush current at the start of a charge cycle. When a charge cycle is initiated, the charge current ramps from zero to the full-scale current over a period of approximately 100us. This has the effect of minimizing the transient current load on the power supply during start-up.

CHG_SB Status Output Pin
The CHG_SB pin can provide an indication that the input voltage is greater than the under-voltage lockout threshold level. A weak pull-down current of approximately 25uA indicates that sufficient voltage is applied to ACIN to begin charging. When a discharged battery is connected to the charger, the constant current portion of the charge cycle begins and the CHG_SB pin pulls to ground. The CHG_SB pin can sink up to 10mA to drive an LED that indicates that a charge cycle is in progress.

When the battery is nearing full charge, the charger enters the constant-voltage portion of the charge cycle and the charge current begins to drop. When the charge current drops below 1/10 of the programmed current, the charge cycle ends and the strong pull-down is replaced by the 25uA pull-down, indicating that the charge cycle has ended. If the input voltage is removed or drops below the under-voltage lockout threshold, the CHG_SB pin becomes high impedance. Figure 5 shows that by using two different value pull-up resistors, a microprocessor can detect all three states from this pin.
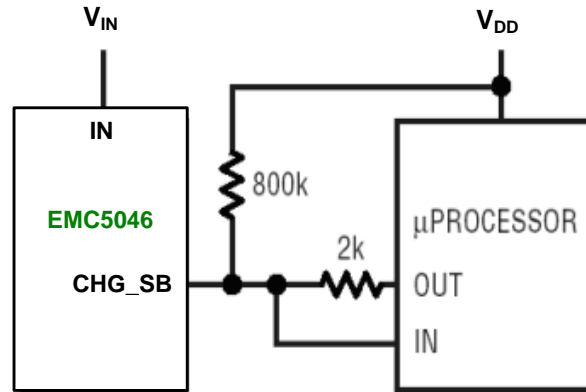
FIG.5 Using a microprocessor to determine CHG_SB state

To detect when the EMC5046 is in charge mode, force the digital output pin (OUT) high and measure the voltage at the CHG_SB pin. The internal N-channel MOSFET will pull the pin voltage low even with the 2k pull-up resistor. Once the charge cycle terminates, the N-channel MOSFET is turned off and a 25uA current source is connected to the CHG_SB pin. The IN pin will then be pulled high by the 2k pull-up resistor. To determine if there is a weak pull-down current, the OUT pin should be forced to a high impedance state. The weak current source will pull the IN pin low through the 800k resistor; if CHG_SB is high impedance, the IN pin will be pulled high, indicating that the part is in a UVLO state.

Reverse Polarity Input Voltage Protection
In some applications, protection from reverse polarity voltage on IN pin is desired. If the supply voltage is high enough, a series blocking diode can be used. In other cases, where the voltage drop must be kept low a P-channel MOSFET can be used (as shown in Figure 6).
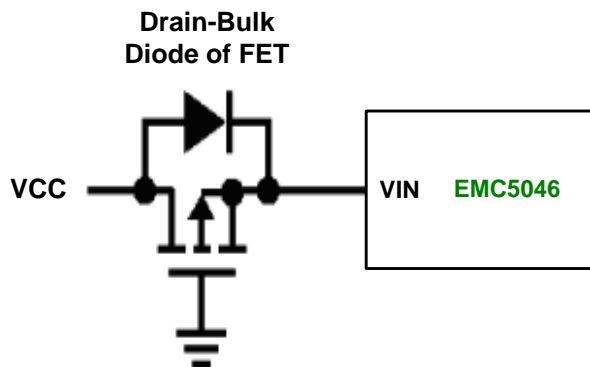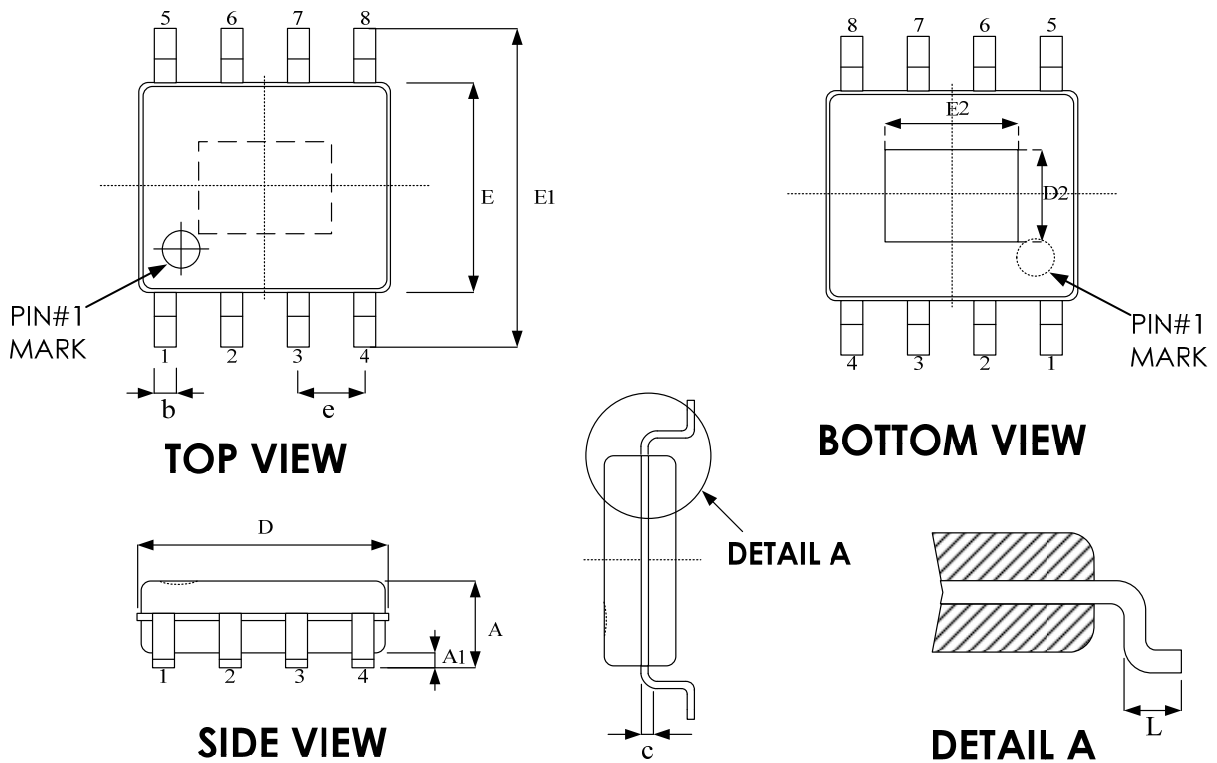
FIG.6 Low loss input reverse polarity protection

Package Outline Drawing
SOP-8 (E) (150 mil)

TOP VIEW

BOTTOM VIEW

SIDE VIEW

DETAIL A

DETAIL A

Symbol	Dimension in mm	
	Min	Max
A	1.35	1.75
A1	0.00	0.25
b	0.33	0.51
c	0.17	0.25
D	4.80	5.00
E	3.81	4.00
E1	5.79	6.20
e	1.27 BSC	
L	0.41	1.27

Exposed pad

Option 1	Dimension in mm	
	Min	Max
D2	2.06	2.31
E2	2.84	3.10

Revision History

Revision	Date	Description
0.1	2012.05.24	Preliminary version.
0.2	2012.06.29	Added V_{RUN} operation in electrical characteristics.